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# RENESAS

# HD151012

8-bit Binary Programmable Counter with Synchronous Preset Enable

> REJ03D0299-0200Z (Previous ADE-205-132 (Z)) Preliminary Rev.2.00 Jul.16.2004

# Description

The HD151012 has 8-bit binary down counter and D-type Flip Flop. The counter can set up to max 256 counts and synchronous preset (SPE) input can preset the data. When the count value is 0, the next clock pulse presets the data to invert the output. D-type Flip Flop takes the counter output as clock pulse, whose data is transferred to output at the rise edge. It is applied to generate AC signal for STN type liquid crystal and general-use divider.

### Features

- High speed operation tpd (CLK or  $\overline{\text{CLK}}$  to Q) = 35 ns (typ)
- High output current Fanout of 10 LS TTL Loads
- Wide operating voltage  $V_{CC} = 2$  to 6 V
- Low supply current (Ta =  $25^{\circ}$ C)  $I_{CC}$  (Static) = 4  $\mu$ A (max)
- Ordering Information

HD151012TELL	TSSOP-16 pin	TTP-16DAV	Т	ELL (2,000 pcs/reel)
Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
Dort Nome	Deekers Ture	Deekege Cede	Deekage	Toning Abbroviation
Ordering Information	.0			
$I_{CC}$ (Static) = 4 $\mu$ A (max)				
• Low supply current (Ta =	25°C)			
$V_{\rm CC} = 2$ to 6 V			<b>S</b> .	
• Wide operating voltage				
Fanout of 10 LS TTL Loa	nds			
• High output current				
tpd (CLK or $\overline{CLK}$ to Q) =	= 35 ns (typ)			
• High speed operation				

# **Function Table**

Co	Control Inputs			
CLR	PR	SPE	Mode	Operation Description
Н	Н	Н	Generally count	Down count at the rise edge of clock (CLK) Down count at the fall edge of clock (CLK)
Х	Х	L	Synchronous preset	Jn data is preset at the rise of clock (CLK), the fall of clock (CLK)
L	Н	—	Initialize of Q output	Initialize of Q = "L"
Н	L	—	Initialize of Q output	Initialize of Q = "H"

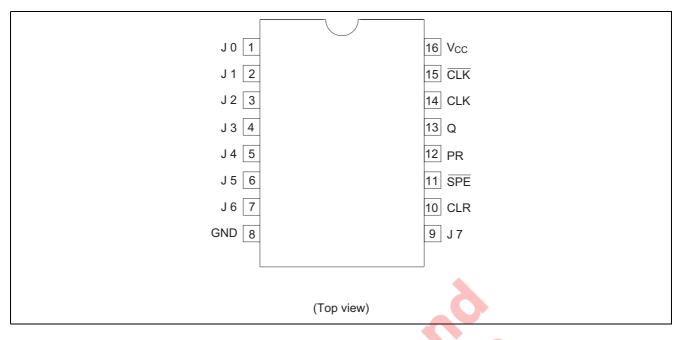
Notes: 1. Synchronous preset (SPE) input can set max 256 down counts.

2. When the count value is 0, the next clock pulse presets the data to invert the output.

- 3. CLR and PR inputs initialize output state.
- Н: High level
- Low level L •
- χ٠ Immaterial
- Irrespective of condition



### **Pin Arrangement**



### **Pin Description**

Pin Name		Pin Description
Input pins	J0 to J7	Count data input for option
	CLK, CLK	Clock inputs CLK : Rise edge trigger
		CLK : Fall edge trigger
	SPE	Preset input for Jn data
	PR	Preset input for D-type Flip Flop (Initialize "L" at Q output)
	CLR	Clear input for D-type Flip Flop (Initialize "H" at Q output)
Output pins	Q	Output for D-type Flip Flop

# Absolute Maximum Ratings

Item	symbol	Ratings	Unit
Supply voltage	V <sub>cc</sub>	–0.5 to 7.0	V
Input / output voltage	V <sub>IN</sub> /V <sub>OUT</sub>	–0.5 to V <sub>cc</sub> +0.5	V
VCC, GND current	I <sub>cc</sub> , IGND	±50	mA
Output current / pin	I <sub>OUT</sub>	±25	mA
Power dissipation	P <sub>T</sub>	500	mW
Storage temperature	Tstg	–65 to 150	°C
Input diode current	I <sub>IK</sub>	±20	mA
Output diode current	Ι <sub>οκ</sub>	±20	mA

Notes: 1. The absolute maximum ratings are values which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

2. All voltage values except for differential input voltage are with respect to network ground terminal.

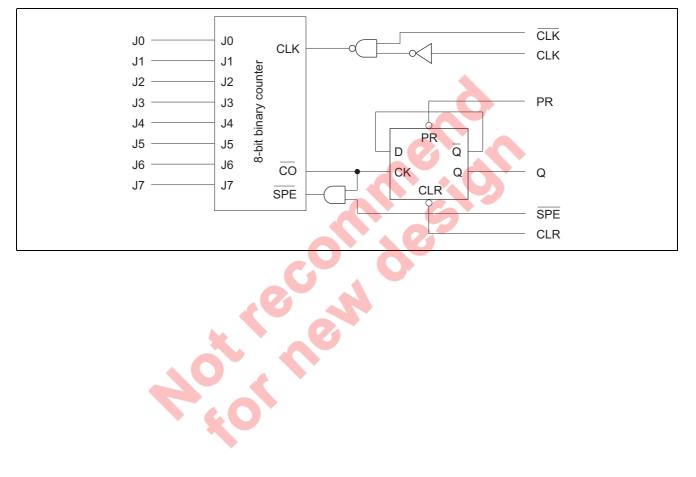


Item		Symbol	Min	Тур	Max	Unit
Supply voltage	e		2	—	6	V
Input/output voltage		V <sub>IN</sub> / <sub>OUT</sub>	0	—	V <sub>cc</sub>	V
Operating temperature		Topr	-40	—	+85	°C
Input rise/fall time*1	$V_{cc} = 2.5 V$	t <sub>r</sub> , t <sub>f</sub>	0	—	1000	ns
	$V_{cc} = 4.5 V$		0	—	500	
	$V_{\rm CC}$ = 5.5 V		0	—	400	

# **Recommended Operating Conditions**

Note: 1. This item guarantees maximum limit when one input switches.

# Logic Diagram





						T	a =			
			т	a = 25°	D'		a – o 85°C			
Item	Symbol	V <sub>cc</sub>	Min	Тур	Max	Min	Max	Unit	Test	Conditions
High level input	V <sub>IH</sub>	2.0	1.5	_	_	1.5	_	V	J0 to J7	
voltage		4.5	3.15	_	—	3.15	—		SPE	
		6.0	4.2	—	—	4.2	—		PR, CLR	
		2.0	1.5	—	—	1.5	—		CLK, CLK	
		4.5	3.15		—	3.15	—			
		6.0	4.2		—	4.2	—			
Low level input	V <sub>IL</sub>	2.0	—		0.5	—	0.5	V	J0 to J7	
voltage		4.5	—		1.35	_	1.35		SPE	
		6.0	—		1.8		1.8		PR, CLR	
		2.0	_	—	0.5	—	0.5		CLK, CLK	
		4.5	—	—	1.35	—	1.35			
		6.0	—	—	1.8	—	1.8			
High level output	V <sub>OH</sub>	2.0	1.9	2.0	—	1.9	—	V	V <sub>IN</sub> =	I <sub>он</sub> = –20 mА
voltage		4.5	4.4	4.5	—	4.4	—		V <sub>IH</sub> or V <sub>IL</sub>	
		6.0	5.9	6.0	—	5.9	—			
		4.5	4.18	4.31	—	4.13	—			I <sub>OH</sub> = -4 mA
		6.0	5.68	5.80	—	5.63	-			I <sub>OH</sub> = -5.2 mA
Low level output	V <sub>OL</sub>	2.0	—	0.0	0.1	-	0.1	V 🌒	V <sub>IN</sub> =	I <sub>OL</sub> = 20 mA
voltage		4.5	—	0.0	0.1	-	0.1		V <sub>IH</sub> or V <sub>IL</sub>	
		6.0	—	0.0	0.1	-	0.1	C		
		4.5	<u> </u>	0.17	0.26		0.33			I <sub>OL</sub> = 4 mA
		6.0	—	0.18	0.26	F_	0.33			I <sub>OL</sub> = 5.2 mA
Input capacitance	I <sub>IN</sub>	6.0	—	- (	±0.1		±1.0	mA	$V_{IN} = V_{CC}$ or GND	
Supply current	I <sub>cc</sub>	6.0	—		4.0		40.0	mA	$V_{IN} = V_{CC}$ or GND	)

# **Electrical Characteristics**





	Sym-	Ta = 25°C		°C	Ta = -40 to 85°C				
Item	bol	$V_{cc}$	Min	Тур	Max	Min	Max	Unit	Test Conditions
Maximum clock	f <sub>max</sub>	2.0	_	_	4	—	3	MHz	
frequency		4.5	_	36	20	—	16		
		6.0	—	—	24	—	19		
Output rise/fall time	t <sub>TLH</sub>	2.0	—	30	75	—	95	ns	
	t <sub>THL</sub>	4.5	—	8	15	—	19		
		6.0	_	7	13	—	16		
Propagation delay	t <sub>PLH</sub>	2.0	—	_	300	—	380		CLK or CLK to Q
time	t <sub>PHL</sub>	4.5	_	35	60	—	75		
		6.0	_	_	53	—	65		
	t <sub>PLH</sub>	2.0	—	—	150	—	185		PR or CLR to Q
	t <sub>PHL</sub>	4.5	_	18	30	—	38		
		6.0	_	_	25	—	32		
Pulse width	tw	2.0	80	—	—	100	_	ns	
(CLK, CLK, PR, CLR)		4.5	16	—	—	20	_		
		6.0	14	—	—	17	_		
Setup time	ts	2.0	100	—	—	125		ns	
(Jn - CLK, CLK)		4.5	20	—	—	25	-	3	
(SPE, CLK, CLK)		6.0	17	—	—	21			
Hold time	th	2.0	15	_	_	15 ┥	-	ns	
(Jn - CLK, CLK)		4.5	10	_	_	10	-		
$(\overline{SPE}, CLK, \overline{CLK})$		6.0	5	_		5	_		
Input capacitance	CIN	_	_	5	10	-	10	pF	
Power dissipation capacitance*1	C <sub>PD</sub>	-		48	5	_	O	pF	

# Switching Characteristics ( $C_L = 50 \text{ pF}, t_r = t_f = 6 \text{ ns}$ )

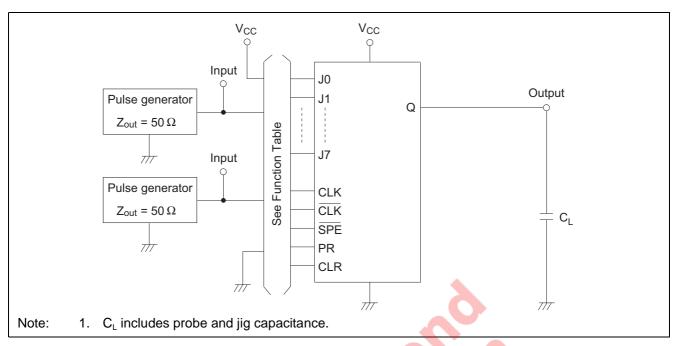
4°0'

Note: 1. CPD is equivalent capacitance inside of the IC calculated from the operating current without load (see test circuit). The average operating current without load is calculated according to the expression below.  $I_{CC}$  (opr) =  $C_{PD} \bullet V_{CC} \bullet f_{IN} + I_{CC}$ 

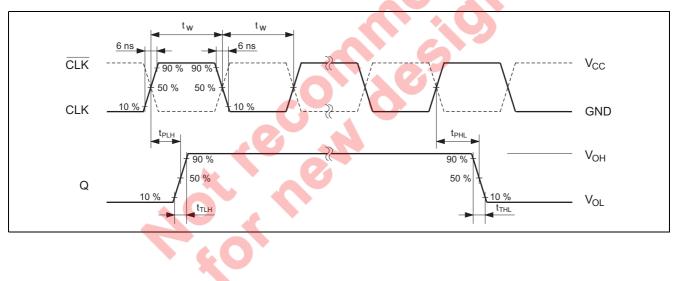


### HD151012

#### **Test Circuit**

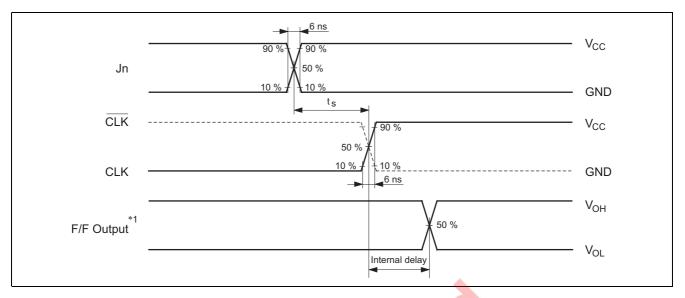




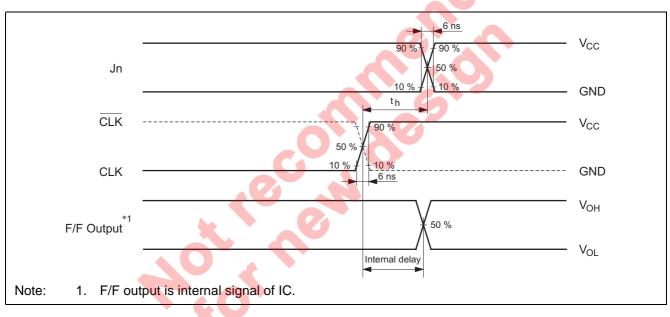




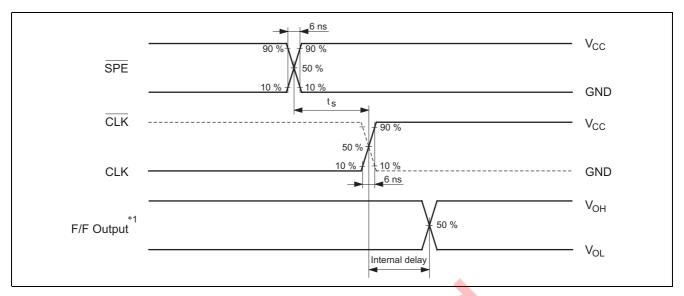
### Waveforms – 2



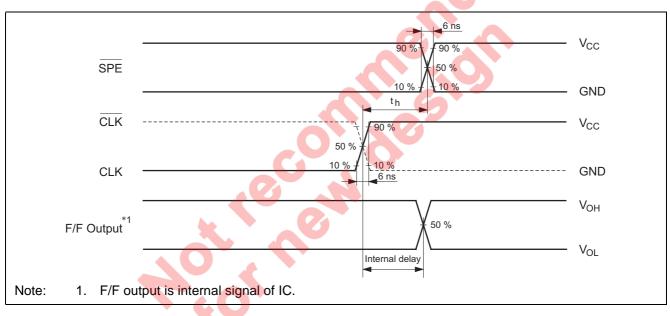




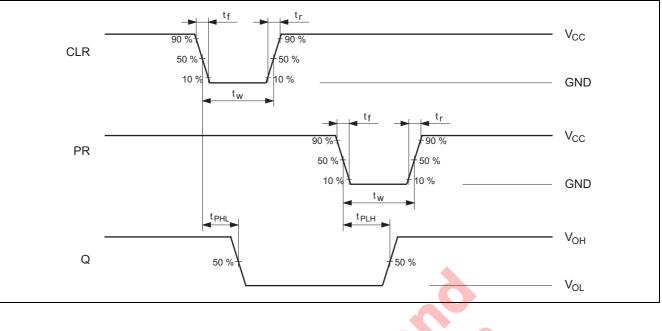
### Waveforms - 4





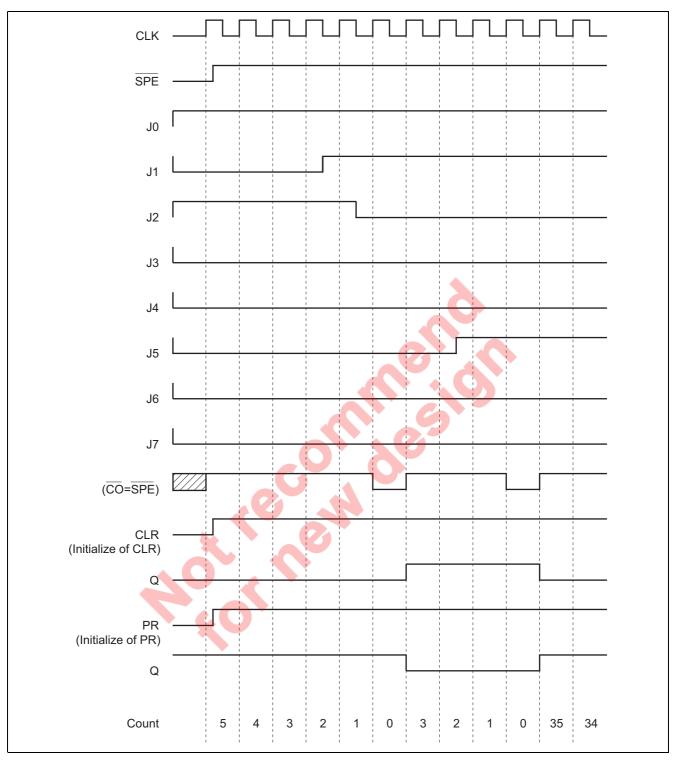


#### Waveforms - 6





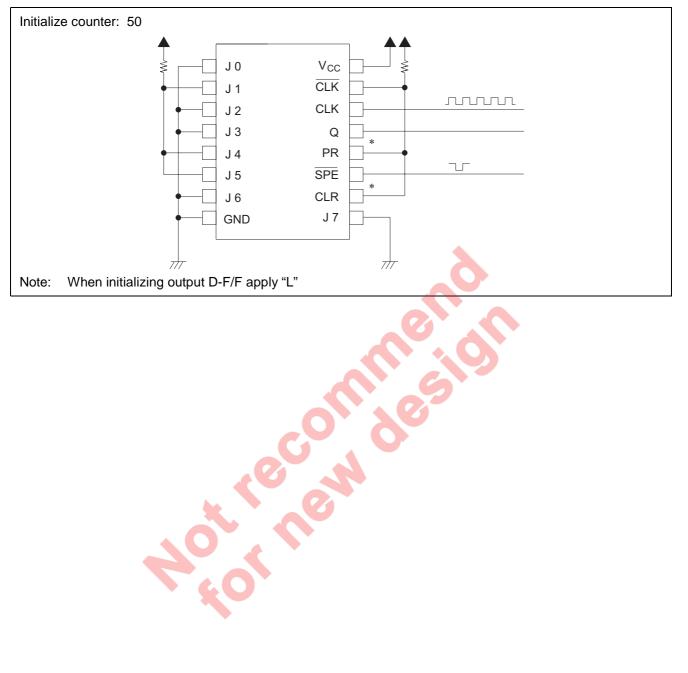
# **Timing Chart**





### **Example of Application Circuit**

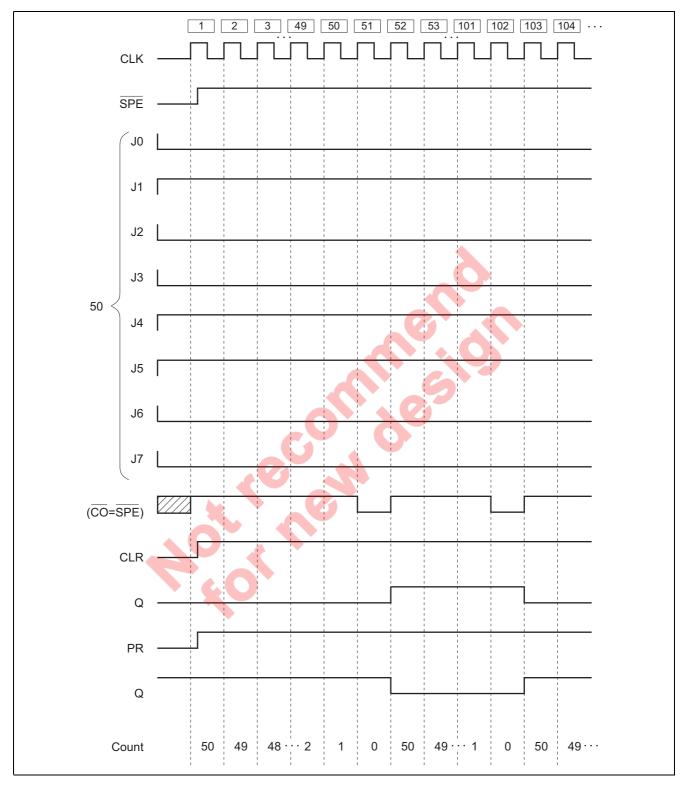
#### AC Signal Generator for STN Type Liquid Crystal Panel





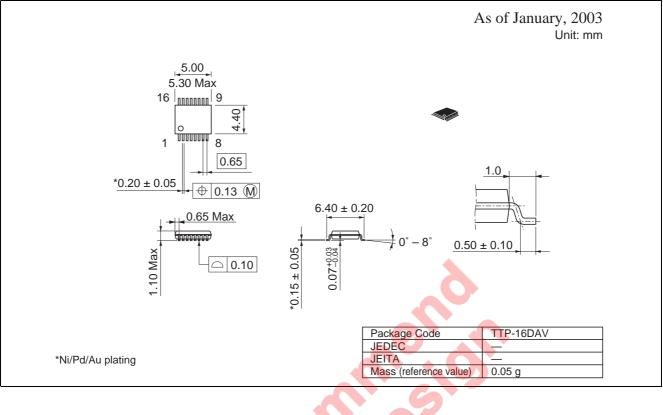
# **Timing Chart**

### Example of AC Signal Generator





### **Package Dimensions**



JEITA Mass (reference v



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